

Patent



IFW

Customer No. 31561
Application No.: 10/708,203
Docket No. 11114-US-PA

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Applicant : Shei et al.
Application No. : 10/708,203
Filed : February 16, 2004
For : LED DEVICE, FLIP-CHIP LED PACKAGE AND LIGHT
REFLECTING STRUCTURE
Examiner :
Art Unit : 2811

ASSISTANT COMMISSIONER FOR PATENTS
Arlington, VA22202

Dear Sirs:

Transmitted herewith is a certified copy of Taiwan Application No.:
092120195, filed on: 2003/07/24.

A return prepaid postcard is also included herewith.

Respectfully Submitted,
JIANQ CHYUN Intellectual Property Office

Dated: July 5, 2004

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